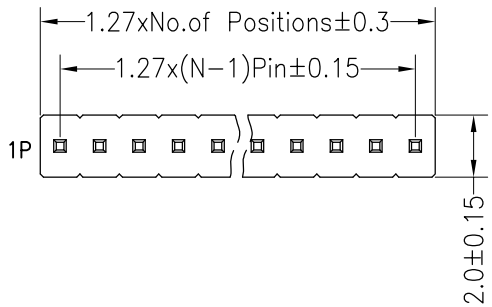
HSF RoHS

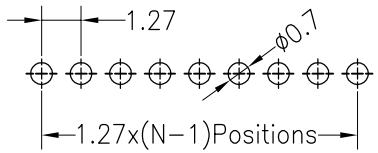
FILE NO :E362810

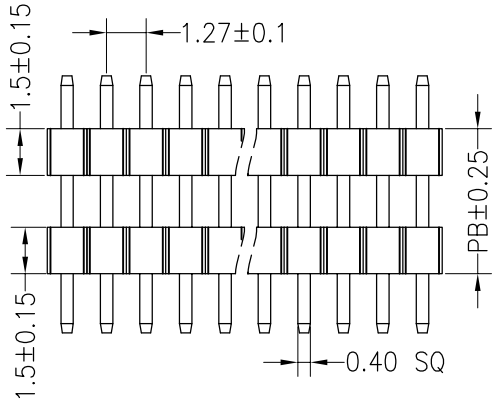
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

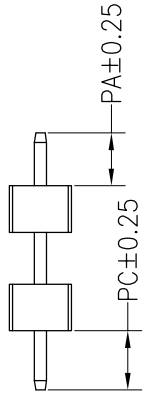
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

1415 21 XX X N XX S XXX X 02

- No.of Pins Per Row 1*1~1*50
- Insulator Material Option
  A=BK−PBT
  B=BK−PA66
  C=BK−PA6T
  D=BK−PA46
  E=BK−PA9T
  F=BK−LCP
- Contact Plating
  G0:Gold Flash
  G1:3U" Gold
  G2:5U" Gold
  G3:10U" Gold
  G4:15U" Gold
  G5:30U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- Pin Length
- Packing
  0=PE Bag
  A=Tray
  T=Tube

Dimension antitheses list				
ITEM	PA	PB	PC	L
Standard	1.80	3.00	3.00	7.80
Alternate				

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2016.05.03	NEW DRAWING	

OPERATION		DRAW	Liu Miao	16.05.03
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	141521XXXNXXSXXXX02
TITLE:	1.27PH 1xnPin H1.5+H1.5mm 180°